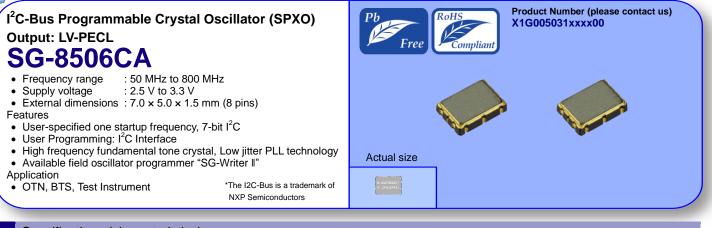
#### SEIKO EPSON CORPORATION



#### Specifications (characteristics)

Item	Symbol	Specifications	Conditions / Remarks		
Output frequency range	fo	50 MHz to 800 MHz	It can be changed by I <sup>2</sup> C		
Supply voltage	V <sub>cc</sub>	2.5 V - 0.125 V to 3.3 V + 0.33 V	-		
Storage temperature	T_stg	-55 °C to +125 °C	Store as bare product after packing		
Operating temperature	T_use	-40 °C to +85 °C	-		
Fraguency tolerance *1	f tol	K : ±31.5 × 10 <sup>-6</sup>	Customized Product (Option)		
Frequency tolerance *1	f_tol	L : ±50 × 10 <sup>-6</sup>			
Current consumption	Icc	90 mA Max.	OE Active, L_ECL=50 Ω		
Disable current	I_dis	40 mA Max.	OE Inactive, Output Standby: Hi-Z mode		
		70 mA Max.	OE Inactive, Output Standby: Fix mode		
Symmetry	SYM	45 % to 55 %	At outputs crossing point		
Output voltogo	V <sub>он</sub>	Vcc - 1.025 V Min.	DC characteristics		
Output voltage	Vol	Vcc - 1.62 V Max.	DC charactenstics		
Output load condition	L_ECL	50 Ω	Termination to Vcc - 2.0 V		
lanut valta na	VIH	70% Vcc Min.			
Input voltage	VIL	30% Vcc Max.	OE, SDA and SCL		
Rise time / Fall time	tr/tf	400 ps Max.	Between 20% and 80% of (VOH - VOL)		
Start-up time	t_str	10 ms Max.	Time at minimum supply voltage to be 0 s		
Setting time for frequency change	t <sub>SET1</sub>	1.5 ms Max.	From setting NEW_FREQ bit to output new frequency		

\*1 Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage change, reflow drift and 10 years aging at +25 °C.

 Product Name
 SG-8506 CA
 156.2MHz
 0x37
 A
 P
 R
 L
 Z

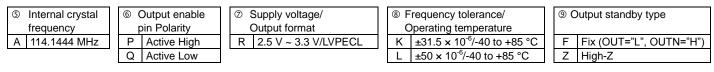
 (Standard form)
 0
 2
 3
 4
 5
 6
 7
 8
 9

Model, 
 Package type,

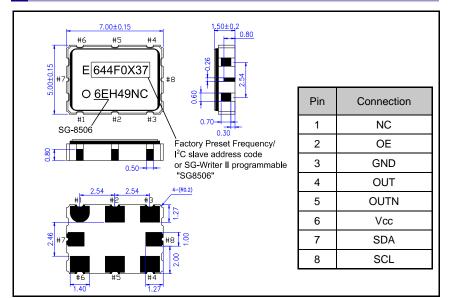
③ Power-on default output frequency (50 ~ 800 MHz), ④ I<sup>2</sup>C slave address, ⑤ Internal crystal frequency,

© Output enable pin Polarity, Ø Supply voltage/Output format, ® Frequency tolerance/Operating temperature, @ Output standby type

(Unit: mm)

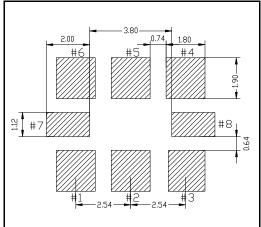


#### External dimensions

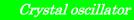


#### Footprint (Recommended)

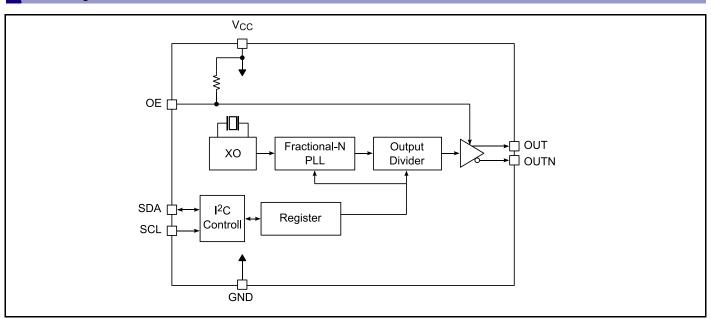
#### commended) (Unit: mm)



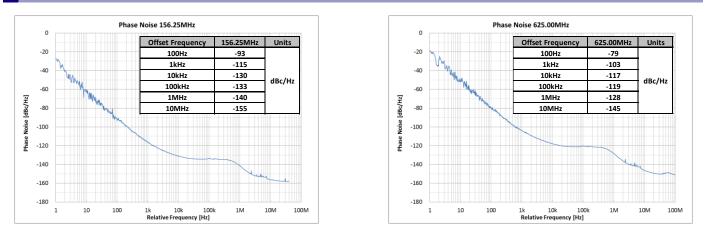
In order to achieve optimum jitter performance, it is recommended that the capacitor (0.1  $\mu F$  + 10  $\mu F)$  between V<sub>CC</sub> and GND pin should be placed as close to the V<sub>CC</sub> pin as possible.



### Block diagram



#### Phase Noise



#### Phase Jitter

	Offset Frequency	100.00 MHz	125.00 MHz	156.25 MHz	250.00 MHz	312.50 MHz	500.00 MHz	625.00 MHz
Phase jitter *2 Typ.	12 kHz to 20 MHz	0.31 ps	0.30 ps	0.26 ps	0.26 ps	0.29 ps	0.28 ps	0.29 ps

\*2 In order to achieve optimum jitter performance, it is recommended that the capacitor (0.1 μF + 10 μF) between V<sub>CC</sub> and GND pin should be placed as close to the V<sub>CC</sub> pin as possible.



Simulation Model

• IBIS model is available. Please contact us.

#### **ESD** Rating

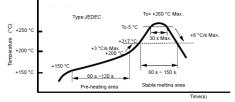
Human Body Model (HBM)	2000 V
Machine Model (MM)	200 V

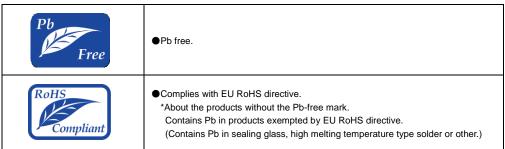
#### **Device Material & Environmental Information**

Model	Package Dimensions	# of Pins	Reference Weight (Typ.)	Terminal Material	Terminal Plating	Complies With EU RoHS	Pb Free	MSL Rating	Peak Temp (Max)
SG-8506CA	7.0 x 5.0 x 1.5 mm	8	167 mg	W	Au	Yes	Yes	1	260 °C

SMD products Reflow profile (example)

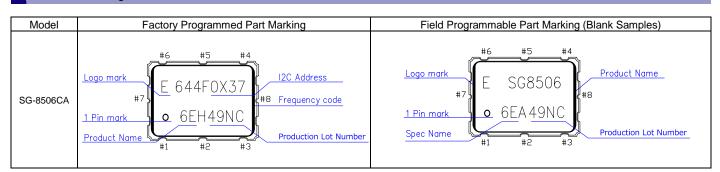
The availability of the heat resistance for reflow conditions of JEDEC-STD-020D.01 is judged individually. Please inquire





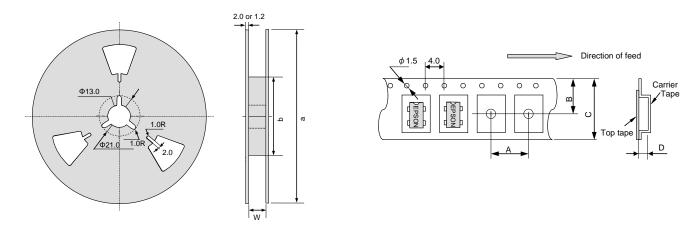


#### Device Marking



#### Standard Packing Specification

SMD products are packed in the shipping carton as below table in accordance with taping standards EIA-481 and IEC-60286



#### Standard Packing Quantity and Dimension (Unit: mm)

Madal	Quantity	Reel dimension			Career Tape dimension				Direction of feed	
Model (pcs/Reel)	(pcs/Reel)	а	b	W	А	В	С	D	(L=left direction)	
SG-8506CA	1000	Ф180	Ф60	17	8	9.25	16	2.1	L	

#### **Application Documents**

- Application Manual (1.5MB)
   <u>http://www5.epsondevice.com/en/products/crystal\_oscillator/sg8506ca.html#</u>
- Evaluation Board Manual Anter (1.1MB)
   <a href="http://www5.epsondevice.com/en/information/support/pdf/sg8506ca\_eva-board\_e.pdf">http://www5.epsondevice.com/en/information/support/pdf/sg8506ca\_eva-board\_e.pdf</a>

# PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

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In order provide high quality and reliable products and services than meet customer needs,

Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired ISO/TS 16949 certification that is requested strongly by major automotive manufacturers as standard.

#### Explanation of the mark that are using it for the catalog

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Pb Free	► Pb free.
RoHS	<ul> <li>Complies with EU RoHS directive.</li> <li>*About the products without the Pb-free mark.</li> <li>Contains Pb in products exempted by EU RoHS directive.</li> <li>(Contains Pb in sealing glass, high melting temperature type solder or other.)</li> </ul>
For Automotive	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
Automotive Safety	► Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc ).

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